Manufacturing Qualifier PhD Qualifier Exam

Reference Book: S. Schmid.	Manufacturing Processes for Engineering Materials, 6th edition, S. Kalpakjian &
Closed book exam:	No Notes (Paper Or Digital Format) or Books Allowed
Duration:	3 hours

This syllabus serves more as a general outline of the topic areas covered on the exam and should **not** be treated as a definitive, complete, topic list.

Fundamentals of the Mechanical Behavior of Materials

Structures: polycrystalline and single crystal, etc. Characterization of mechanical properties: strength, hardness, toughness etc. Heat treatments: quenching, tempering etc. Properties of ferrous and nonferrous metals and alloys

Surfaces, Subsurface, Dimensional Characteristics, Inspection and Quality Assurance

Surface and subsurface structure, integrity and properties, Tribology Surface texture, dimensional Metrology Testing, inspection and quality assurance

Casting Processes

Solidification of Metals Casting structures and characteristic properties Fluid flow and heat transfer Ingot casting, continuous casting, investment and die

Deformation Processes

Sheet metal processes, Forging, Rolling, Extrusion, Rod, Wire and tube drawing, swaging, peening, etc.

Material Removal Processes- Cutting

Turning, milling, drilling, broaching etc. Mechanics of chip formation and material removal Tool Materials, tool wear, machinability, surface finish and integrity Vibration and chatter

Material Removal Processes-Abrasive

Grinding, lapping, polishing, honing, etc. Abrasives, mechanics of grinding, finishes obtainable and SSD

Material Removal Processes-other/non traditional

Chemical, electrical and high energy-beams based processes Removal mechanisms and applications

Processing of Polymers and Reinforced Plastics

General properties, characteristics, and applications of thermoplastics, thermosets and reinforced plastics (composites),. Suitable processing technologies

Processing of Powder Metals and Ceramics Joining and Fastening Processes

Soldering, brazing, welding, riveting, etc.

IC manufacture

Key materials and their properties and fabrication Structure of ICs Basic fabrication steps (deposition, removal, patterning etc.)

Manufacturing Automation and Integrated Manufacturing

Numerical Control Adaptive control Group technology and cellular manufacturing Flexible manufacturing systems

Additive Manufacturing

Polymer AM process fundamentals: Stereolithography, polyjet, fused deposition modeling, selective laser sintering, binder jet Metal AM process fundamentals: Laser/electron beam powder bed fusion, binder jet, powder- and wirefed directed energy deposition, wire-arc AM Design for AM Process and material defects Tradeoffs between AM and conventional processes